VSMY12940



Vishay Semiconductors

High Speed Infrared Emitting Diodes, 940 nm, Surface Emitter Technology

FEATURES

• High reliability

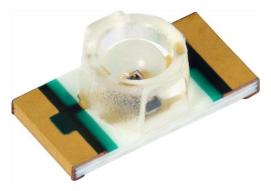
· High radiant power

· Very high radiant intensity

· Package type: surface mount · Package form: top view

Peak wavelength: λ_p = 940 nm

• Angle of half intensity: $\varphi = \pm 40^{\circ}$



DESCRIPTION

As part of the SurfLight[™] portfolio, the VSMY12940 is an infrared, 940 nm, top looking emitting diode based on GaAlAs surface emitter chip technology with extreme high radiant intensities, high optical power and high speed, molded in clear, untinted PCB based package (with inner lens) for surface mounting (SMD).

APPLICATIONS

- Emitter for proximity applications
- IR touch panels
- Photointerrupters
- · Optical switch

PRODUCT SOMMART				
COMPONENT	l _e (mW/sr)	φ (deg)	λ _p (nm)	t _r (ns)
VSMY12940	16	± 40	940	10

Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING REMARKS		PACKAGE FORM	
VSMY12940	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	Top view	

Note

· MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V _R	5	V	
Forward current		l _F	70	mA	
Surge forward current	t _p = 100 μs	I _{FSM}	1	A	
Power dissipation		Pv	140	mW	
Junction temperature		Tj	100	°C	
Operating temperature range		T _{amb}	-40 to +85	°C	
Storage temperature range		T _{stg}	-40 to +100	°C	
Soldering temperature	acc. figure 10, J-STD-020	T _{sd}	260	°C	
Thermal resistance junction/ambient	J-STD-051, soldered on PCB	R _{thJA}	390	K/W	

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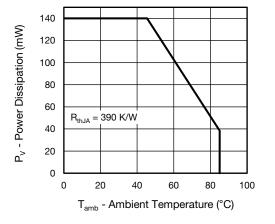


(5-2008)

· Suitable for high pulse current operation

• Dimensions (L x W x H in mm): 3.2 x 1.6 x 1.1

- Floor life: 168 h, MSL 3, according to J-STD-020
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



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Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

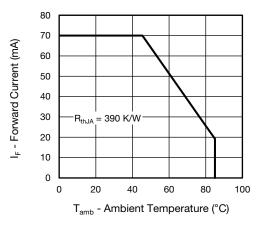


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 20 \text{ mA}, t_p = 20 \text{ ms}$	V _F	1.1	1.4	1.9	V
	I _F = 70 mA, t _p = 20 ms	V _F		1.6		V
	I _F = 1 A, t _p = 100 μs	V _F		2.8		V
Temperature coefficient of V _F	I _F = 20 mA	TK _{VF}		-1.7		mV/K
Reverse current		I _R	not designed for reverse operation		μA	
Junction capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0 mW/cm^{2}$	CJ		5		pF
Radiant intensity	$I_F = 20 \text{ mA}, t_p = 20 \text{ ms}$	l _e	2.3	4.7		mW/sr
	I _F = 70 mA, t _p = 20 ms	l _e		16		mW/sr
	I _F = 1 A, t _p = 100 μs	l _e		130		mW/sr
Radiant power	I _F = 70 mA, t _p = 20 ms	фе		40		mW
Temperature coefficient of radiant power	I _F = 20 mA	ΤKφ _e		-0.19		%/K
Angle of half intensity		φ		± 40		deg
Peak wavelength	I _F = 20 mA	λρ	920	940	960	nm
Spectral bandwidth	I _F = 20 mA	Δλ		35		nm
Temperature coefficient of λ_p	I _F = 20 mA	ΤΚλρ		0.25		nm/K
Rise time	I _F = 100 mA, 20 % to 80 %	tr		10		ns
Fall time	I _F = 100 mA, 20 % to 80 %	t _f		10		ns

BASIC CHARACTERISTICS (Tamb = 25 °C, unless otherwise specified)

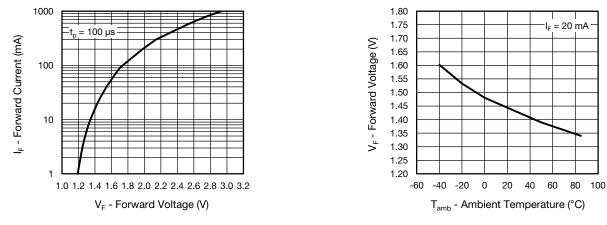


Fig. 3 - Forward Current vs. Forward Voltage

Fig. 4 - Forward Voltage vs. Ambient Temperature

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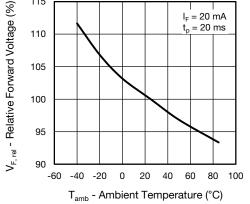


Fig. 5 - Relative Forward Voltage vs. Ambient Temperature

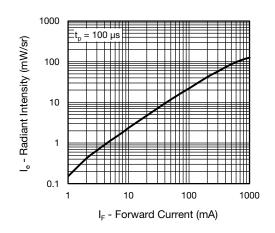


Fig. 6 - Radiant Intensity vs. Forward Current

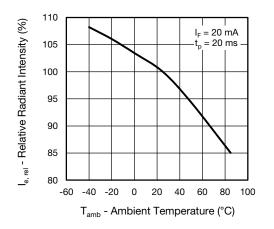


Fig. 7 - Relative Radiant Intensity vs. Ambient Temperature

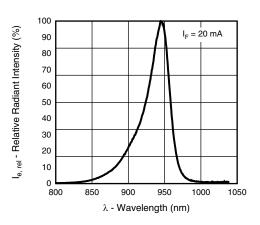


Fig. 8 - Relative Radiant Intensity vs. Wavelength

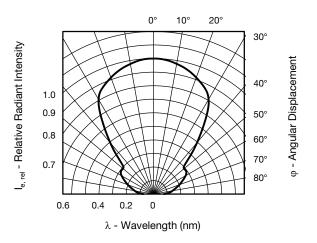


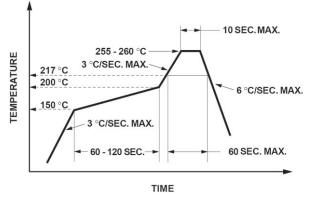
Fig. 9 - Relative Radiant Intensity vs. Angular Displacement

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SOLDER PROFILE

ISHA



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Fig. 10 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

PACKAGE DIMENSIONS in millimeters: VSMY12940

DRYPACK

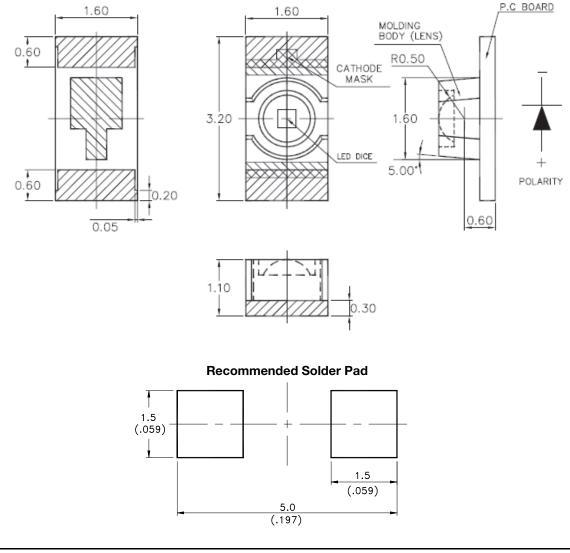
Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label: Floor life: 168 h Conditions: $T_{amb} < 30$ °C, RH < 60 % Moisture sensitivity level 3, according to J-STD-020.

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 %.



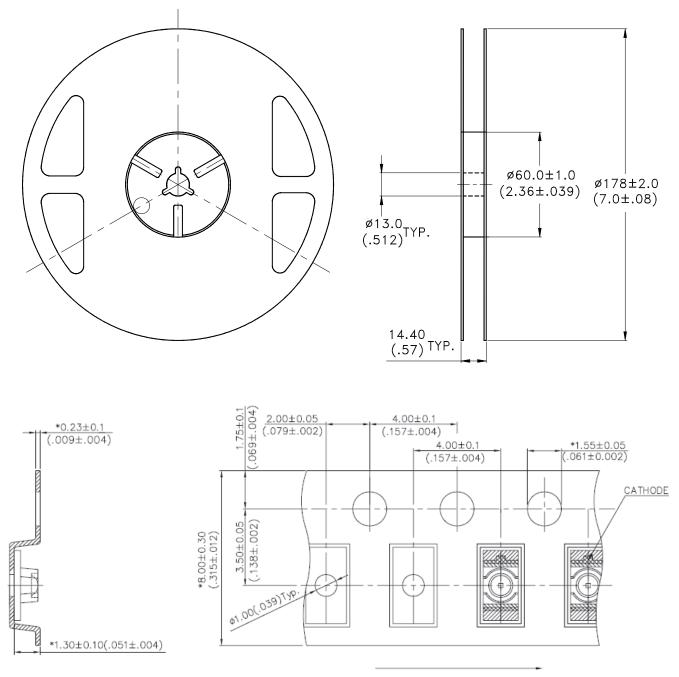
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TAPING AND REEL DIMENSIONS in millimeters: VSMY12940



User Feed Direction



Vishay

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